



DOCUMENT CHANGE REQUEST

DCR number 669

Changes required for: N/A

Originator: John Wong

Date: 2012/08/27

Date sent: 2011/05/12

Organisation: ESTEC

Status: IMPLEMENTED

Title: ESCC Qualified Manufacturers List REP006

Number: REP006

Issue: 8

Other documents affected:

Page:

New para. 5.3

Paragraph:

Attached Technology Flow Abstract for Atmel 180 nm ATC18RHA process

Original wording:

New para. 5.3

Proposed wording:

Attached Technology Flow Abstract for Atmel 180 nm ATC18RHA process

Justification:

New certification following completion of ESCC QML program

Attachments:

120726_cf_0_18_μm_rha_technology_flow_domain_abstract_cf_rev.d.doc, null

Modifications:

changes to Issue 8 and introduction of Para. 5.4 instead of 5.3

Approval signature:

Date signed:

2012-08-27